



20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

| V _(BR) dss | R _{DS(on)} Max | I _D max T _A = 25°C (Notes 4) |
|-----------------------|--|--|
| | $200m\Omega @ V_{GS} = 4.5V$ | 1.73A |
| 20V | 260m Ω @ V _{GS} = 2.5V | 1.50A |
| | $400m\Omega @ V_{GS} = 1.8V$ | 1.27A |
| | 500mΩ @ V _{GS} = 1.5V | 1.15A |

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

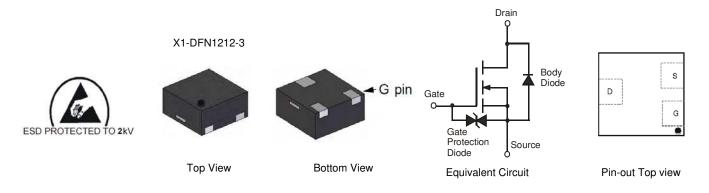
Load switch

Features and Benefits

- Low Gate Threshold Voltage •
- Fast Switching Speed •
- "Lead Free", RoHS Compliant (Note 1) •
- Halogen and Antimony Free. "Green" Device (Note 2)
- **ESD Protected Gate 2KV**
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: X1-DFN1212-3
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.005 grams (approximate)



Ordering Information (Note 3)

| Part Number | Marking | Reel size (inches) | Tape width (mm) | Quantity per reel |
|--------------|---------|--------------------|-----------------|-------------------|
| DMN2300UFD-7 | KS2 | 7 | 8 | 3000 |

Notes: 1. No purposefully added lead

2. Diodes Inc's "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information

| | KS2 | |
|---|-----|--|
| | YM | |
| • | | |

KS2 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011)M = Month (ex: 9 = September)

Date Code Key

| Eate eede hej | | | | | | | | | | | | |
|---------------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Year | 201 | 1 | 2012 | | 2013 | 20 | 14 | 2015 | | 2016 | 2 | 2017 |
| Code | Y | | Z | | А | E | 3 | С | | D | | E |
| Month | Jan | Feb | Mar | Apr | Мау | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |





Maximum Ratings @TA = 25°C unless otherwise specified

| Characteristic | | | Symbol | Value | Unit |
|-------------------------------|-----------------|--------------------------------|------------------|-------|------|
| Drain-Source Voltage | | | V _{DSS} | 20 | V |
| Gate-Source Voltage | | | V _{GSS} | ±8 | V |
| | | T _A = 25°C (Note 4) | | 1.73 | |
| | Steady State | T _A = 85°C (Note 4) | I _D | 1.34 | А |
| | Siale | T _A = 25°C (Note 5) | | 1.21 | |
| Pulsed Drain Current (Note 6) | | | I _{DM} | 6.0 | А |

Thermal Characteristics @TA = 25°C unless otherwise specified

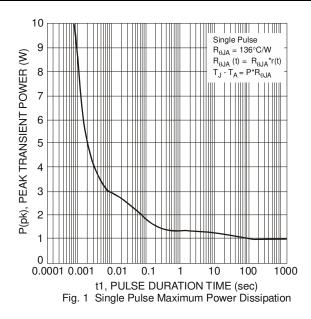
| Characteristic | Symbol | Value | Unit | |
|---|----------|-----------------------------------|-------------|------|
| Power Dissipation | (Note 4) | Р | 0.96 | W |
| | (Note 5) | PD | 0.47 | W |
| Thermel Decistance Junction to Ambient | (Note 4) | | 130 | °C/W |
| Thermal Resistance, Junction to Ambient | (Note 5) | R _{eja} | 265 | °C/W |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C |

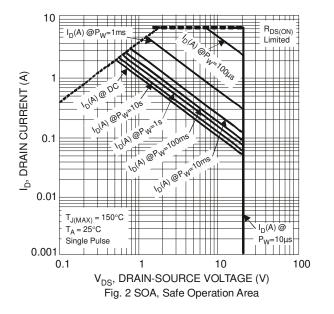
Notes: 4. For a device surface mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of 2oz copper, in still air conditions; the device is measured when operating in a steady-state condition.

5. Same as note 4, except the device is mounted on minimum recommended pad layout.

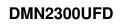
6. Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.

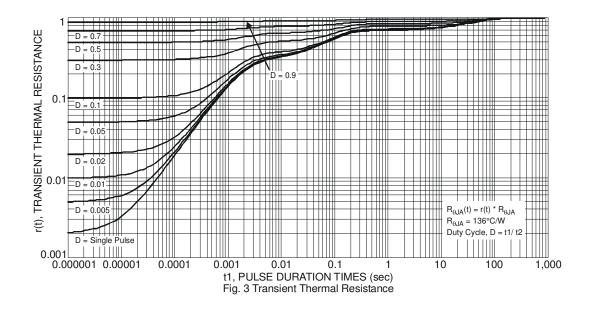
Thermal Characteristics











Electrical Characteristics @T_A = 25°C unless otherwise specified

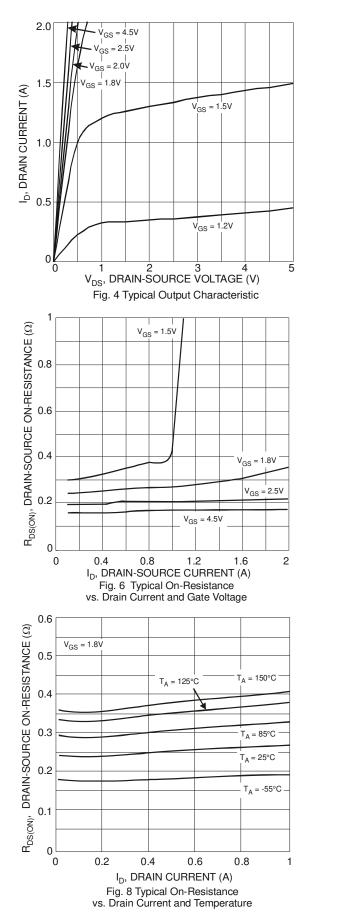
| Characteristic | Cumhal | Min | True | Max | Unit | Test Condition | |
|---|----------------------|------|-------|------|------|--|--|
| | Symbol | Min | Тур | Max | Unit | Test Condition | |
| OFF CHARACTERISTICS (Note 7) | DV/ | 00 | 1 | i | V | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 20 | - | - | V | $V_{GS} = 0V, I_D = 250\mu A$ | |
| Zero Gate Voltage Drain Current T _J = 25°C | I _{DSS} | - | - | 1 | μA | $V_{DS} = 20V, V_{GS} = 0V$ | |
| Gate-Source Leakage | I _{GSS} | - | - | ±10 | μΑ | $V_{GS} = \pm 8V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 7) | | | | i | | | |
| Gate Threshold Voltage | V _{GS(th)} | 0.45 | - | 0.95 | V | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | |
| | | | | 200 | | $V_{GS} = 4.5V, I_D = 900mA$ | |
| Static Drain-Source On-Resistance | D | | | 260 | | $V_{GS} = 2.5V, I_D = 800mA$ | |
| Static Drain-Source On-Resistance | R _{DS (ON)} | - | - | 400 | mΩ | V _{GS} = 1.8V, I _D = 700mA | |
| | | | | 500 | | $V_{GS} = 1.5V, I_D = 200mA$ | |
| Forward Transfer Admittance | Y _{fs} | 40 | - | - | mS | $V_{DS} = 3V, I_{D} = 300mA$ | |
| Diode Forward Voltage | V _{SD} | - | 0.7 | 1.2 | V | V _{GS} = 0V, I _S = 300mA | |
| DYNAMIC CHARACTERISTICS | | | | | | - | |
| Input Capacitance | C _{iss} | - | 67.62 | - | pF | | |
| Output Capacitance | Coss | - | 9.74 | - | pF | − V _{DS} = 25V, V _{GS} = 0V, − f = 1.0MHz | |
| Reverse Transfer Capacitance | C _{rss} | - | 7.58 | - | pF | 1 = 1.000112 | |
| Gate Resistance | Rg | - | 68.51 | - | Ω | $V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$ | |
| Total Gate Charge (Note 8) | Qg | - | 0.89 | 2 | nC | | |
| Gate-Source Charge | Q _{gs} | - | 0.14 | - | nC | $-V_{GS} = 4.5V, V_{DS} = 15V,$ $-I_{D} = 1A$ | |
| Gate-Drain Charge | Q _{gd} | - | 0.16 | - | nC | | |
| Turn-On Delay Time | t _{D(on)} | - | 4.92 | - | ns | | |
| Turn-On Rise Time | tr | - | 6.93 | - | ns | V _{DS} = 10V, I _D = 1A | |
| Turn-Off Delay Time | t _{D(off)} | - | 21.71 | - | ns | $V_{GS} = 10V, R_{G} = 6\Omega$ | |
| Turn-Off Fall Time | t _f | - | 10.62 | - | ns | | |

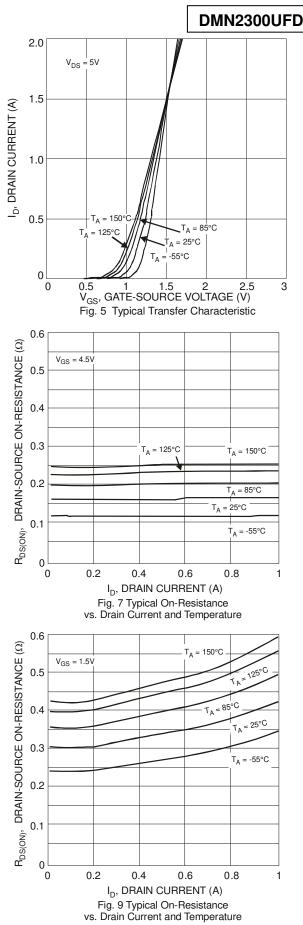
Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guarantee by design.



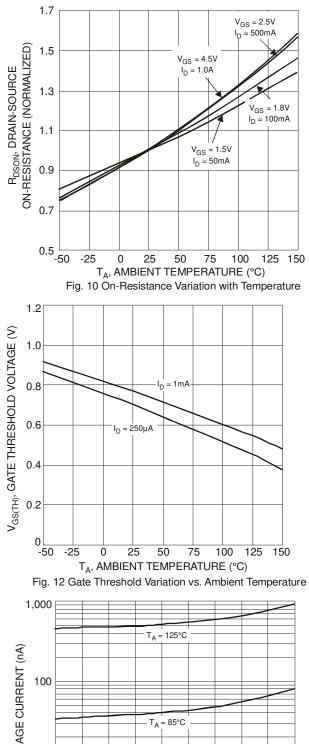
A Product Line of Diodes Incorporated

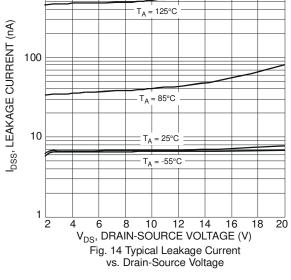






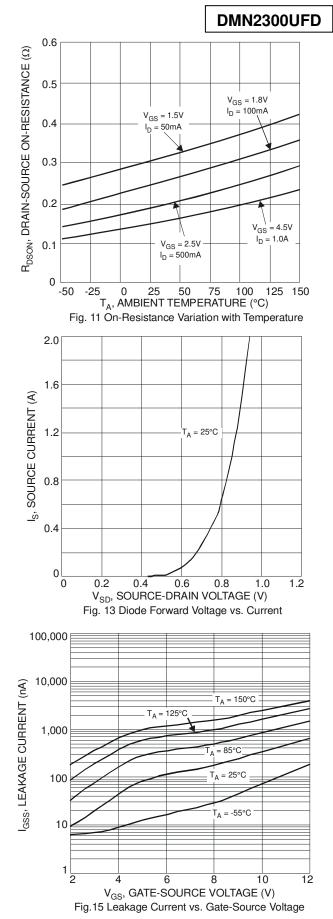






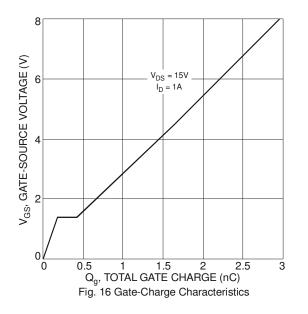
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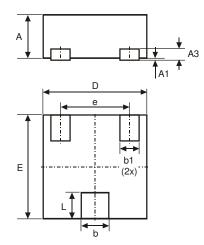






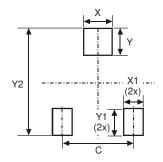


Package Outline Dimensions



| Х | X1-DFN1212-3 | | | | | | | |
|--------|--------------|--------|------|--|--|--|--|--|
| Dim | Min | Max | Тур | | | | | |
| Α | 0.47 | 0.53 | 0.50 | | | | | |
| A1 | 0 | 0.05 | 0.02 | | | | | |
| A3 | - | • | 0.13 | | | | | |
| b | 0.27 | 0.37 | 0.32 | | | | | |
| b1 | 0.17 | 0.27 | 0.22 | | | | | |
| D | 1.15 | 1.25 | 1.20 | | | | | |
| Ε | 1.15 | 1.25 | 1.20 | | | | | |
| е | - | - | 0.80 | | | | | |
| L | 0.25 | 0.35 | 0.30 | | | | | |
| All Di | mens | ions i | n mm | | | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 0.80 |
| Х | 0.42 |
| X1 | 0.32 |
| Y | 0.50 |
| Y1 | 0.50 |
| Y2 | 1.50 |

DMN2300UFD Datasheet Number: DS35443 Rev. 2 - 2



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